Renesas Electronics America Inc - M30845FWGP#U5 Datasheet

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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	M32C/80
Core Size	16/32-Bit
Speed	32MHz
Connectivity	CANbus, I²C, IEBus, SIO, UART/USART
Peripherals	DMA, PWM, WDT
Number of I/O	121
Program Memory Size	320KB (320K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	24K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 34x10b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-20°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	144-LQFP
Supplier Device Package	144-LFQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/m30845fwgp-u5

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1. Overview

The M32C/84 group (M32C/84, M32C/84T) microcomputer is a single-chip control unit that utilizes high-performance silicon gate CMOS technology with the M32C/80 series CPU core. The M32C/84 group (M32C/84, M32C/84T) is available in 144-pin and 100-pin plastic molded LQFP/QFP packages.

With a 16-Mbyte address space, this microcomputer combines advanced instruction manipulation capabilities to process complex instructions by less bytes and execute instructions at higher speed.

It includes a multiplier and DMAC adequate for office automation, communication devices and industrial equipments, and other high-speed processing applications.

1.1 Applications

Automobiles, audio, cameras, office equipment, communications equipment, portable equipment, etc.

1.2 Performance Overview

Tables 1.1 and 1.2 list performance overview of the M32C/84 group (M32C/84, M32C/84T).

Table 1.1 M32C/84 Group (M32C/84, M32C/84T) Performance (144-Pin Package)

Characteristic		Performance	
		M32C/84	M32C/84T
CPU	Basic Instructions	108 instructions	
	Shortest Instruction Execution Time	31.3 ns (f(BCLK)=32 MHz, V_{CC1}=4.2 V to 5.5 V) 41.7 ns (f(BCLK)=24 MHz, V_{CC1}=3.0 V to 5.5 V)	31.3 ns (f(BCLK)=32 MHz, V_{CC1}=4.2 V to 5.5 V)
	Operation Mode	Single-chip mode, Memory expansion mode and Microprocessor mode	Single-chip mode
	Address Space	16 Mbytes	
	Memory Capacity	See Table 1.3	
Peripheral Function	I/O Port	123 I/O pins and 1 input pin	
	Multifunction Timer	Timer A: 16 bits x 5 channels, Timer B: 16 bits x 6 channels Three-phase motor control circuit	
	Intelligent I/O	Time measurement function or Waveform generating function: 16 bits x 8 channels Communication function (Clock synchronous serial I/O, Clock asynchronous serial I/O, HDLC data processing)	
	Serial I/O	5 Channels Clock synchronous serial I/O, Clock asynchronous serial I/O, IEBus(1), I^2C bus(2)	
	CAN Module	1 channel Supporting CAN 2.0B specification	
	A/D Converter	10-bit A/D converter: 1 circuit, 34 channels	
	D/A Converter	8 bits x 2 channels	
	DMAC	4 channels	
	DMAC II	Can be activated by all peripheral function interrupt sources Immediate transfer, Calculation transfer and Chain transfer functions	
	CRC Calculation Circuit	CRC-CCITT	
	X/Y Converter	16 bits x 16 bits	
	Watchdog Timer	15 bits x 1 channel (with prescaler)	
	Interrupt	38 internal and 8 external sources, 5 software sources Interrupt priority level: 7	
	Clock Generation Circuit	4 circuits Main clock oscillation circuit(*), Sub clock oscillation circuit(*), On-chip oscillator, PLL frequency synthesizer (*)Equipped with a built-in feedback resistor. Ceramic resonator or crystal oscillator must be connected externally	
	Oscillation Stop Detect Function	Main clock oscillation stop detect function	
	Voltage Detection Circuit	Available (optional)	Not available(4)
Electrical Characteristics	Supply Voltage	V_{CC1}=4.2 V to 5.5 V, V_{CC2}=3.0 V to V_{CC1} (f(BCLK)=32 MHz) V_{CC1}=3.0 V to 5.5 V, V_{CC2}=3.0 V to V_{CC1} (f(BCLK)=24 MHz)	V_{CC1}=V_{CC2}=4.2 V to 5.5 V, (f(BCLK)=32 MHz)(3)
	Power Consumption	28 mA (V_{CC1}=V_{CC2}=5 V, f(BCLK)=32 MHz) 22 mA (V_{CC1}=V_{CC2}=3.3 V, f(BCLK)=24 MHz) 10µA (V_{CC1}=V_{CC2}=5 V, f(BCLK)=32 kHz, in wait mode)	28 mA (V_{CC1}=V_{CC2}=5 V, f(BCLK)=32 MHz) 10µA (V_{CC1}=V_{CC2}=5 V, f(BCLK)=32 kHz, in wait mode)
Flash Memory	Program/Erase Supply Voltage	3.3 V ± 0.3 V or 5.0 V ± 0.5 V	5.0 V ± 0.5 V
	Program and Erase Endurance	100 times (all space)	
Operating Ambient Temperature		–20 to 85°C –40 to 85°C (optional)	–40 to 85°C (T version)
Package		144-pin plastic molded LQFP	

NOTES:
1. IEBus is a trademark of NEC Electronics Corporation.
2. I^2C bus is a trademark of Koninklijke Philips Electronics N. V.
3. The supply voltage of M32C/84T (High-reliability version) must be V_{CC1}=V_{CC2}.
4. The cold start-up/warm start-up determine function is available only at the user's option.

All options are on a request basis.

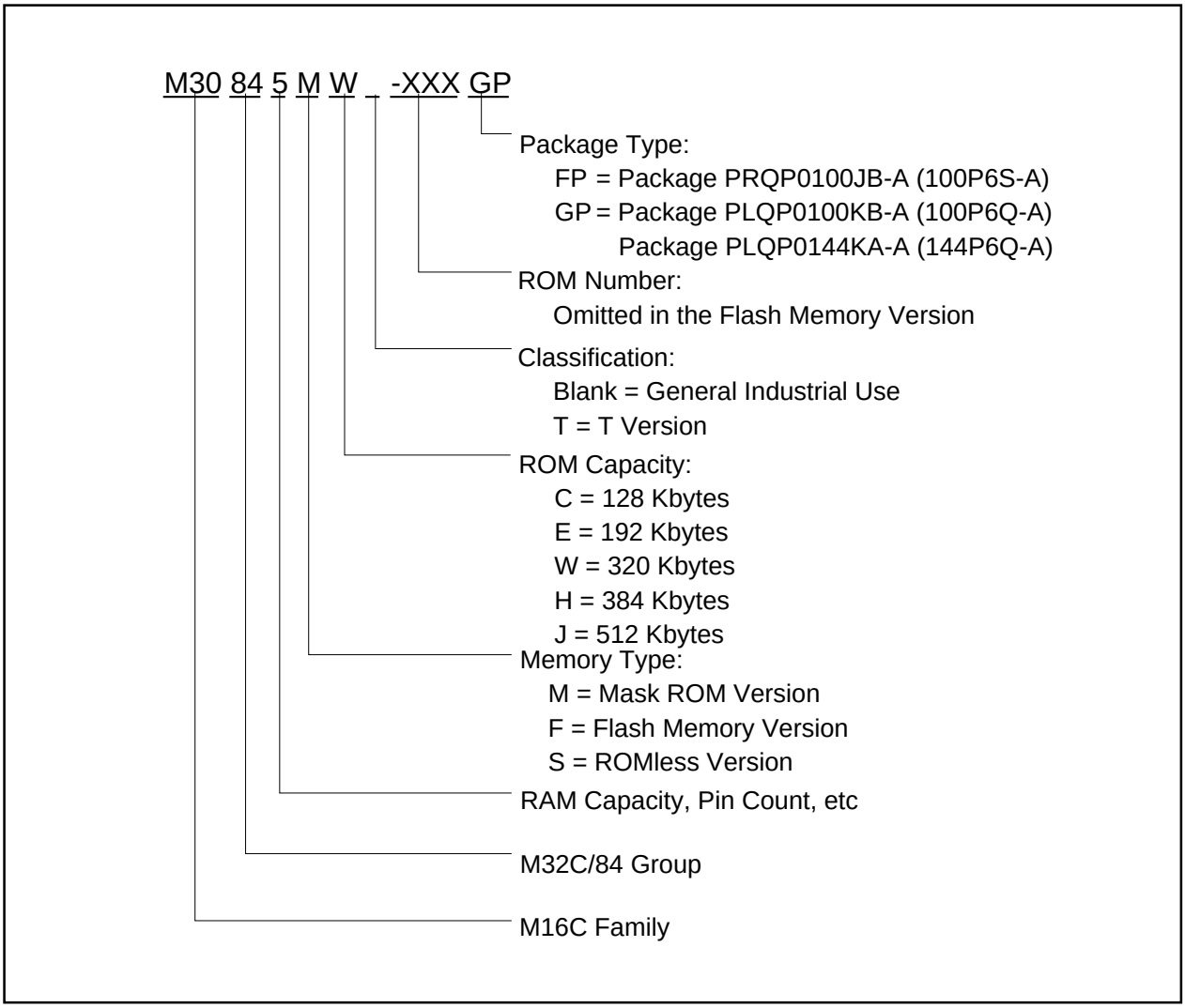


Figure 1.2 Product Numbering System

1.5 Pin Assignments and Descriptions

Figures 1.3 to 1.5 show pin assignments (top view).

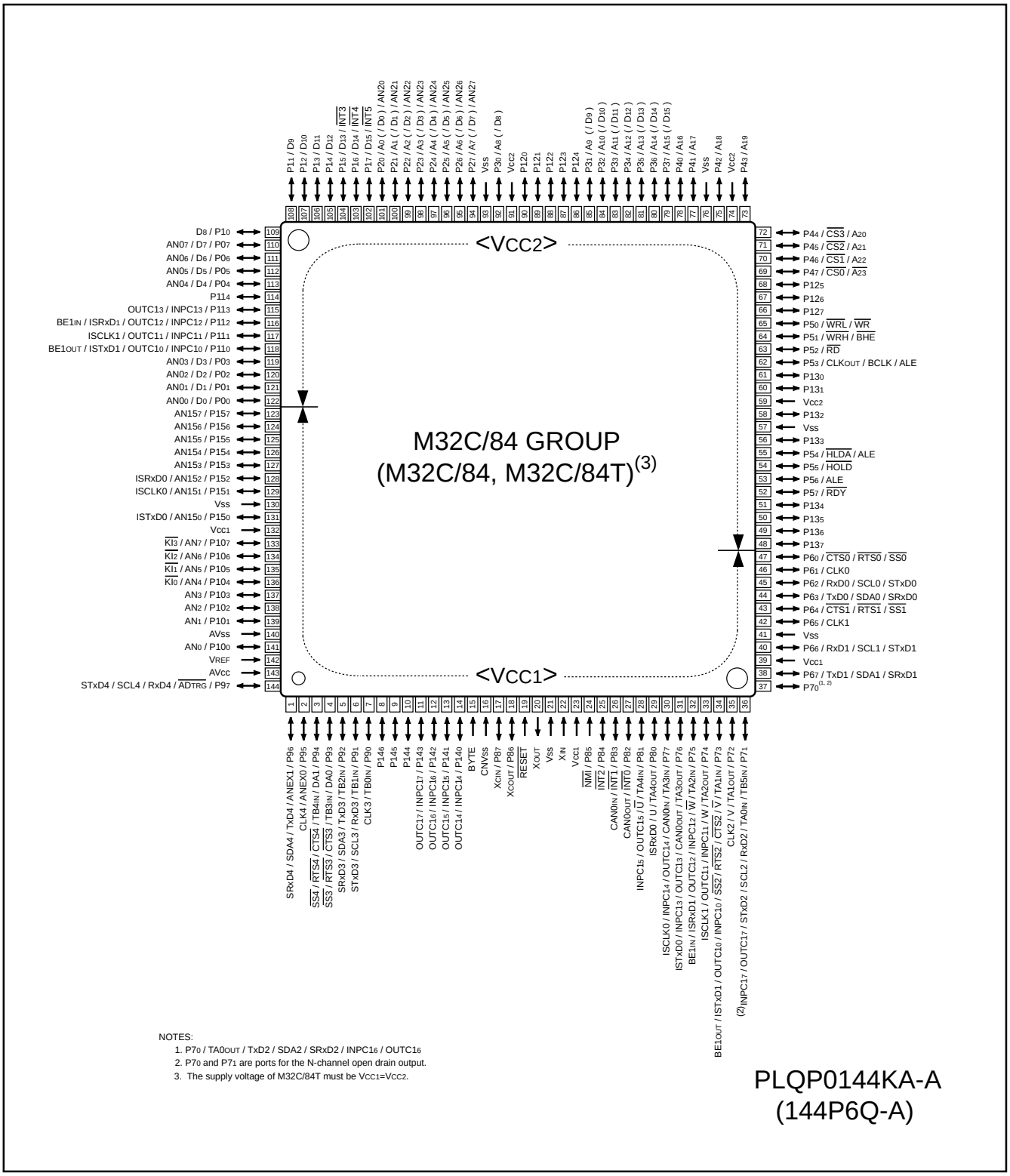


Figure 1.3 Pin Assignment for 144-Pin Package

Table 1.4 Pin Characteristics for 144-Pin Package (Continued)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART/CAN Pin	Intelligent I/O Pin	Analog Pin	Bus Control Pin
49		P13$_6$						
50		P13$_5$						
51		P13$_4$						
52		P5$_7$						$\overline{\text{RDY}}$
53		P5$_6$						ALE
54		P5$_5$						$\overline{\text{HOLD}}$
55		P5$_4$						$\overline{\text{HLDA}}$/ALE
56		P13$_3$						
57	V_{SS}							
58		P13$_2$						
59	V_{CC2}							
60		P13$_1$						
61		P13$_0$						
62		P5$_3$						CLK$_{OUT}$/BCLK/ALE
63		P5$_2$						$\overline{\text{RD}}$
64		P5$_1$						$\overline{\text{WRH}}$/$\overline{\text{BHE}}$
65		P5$_0$						$\overline{\text{WRL}}$/$\overline{\text{WR}}$
66		P12$_7$						
67		P12$_6$						
68		P12$_5$						
69		P4$_7$						$\overline{\text{CS0}}$/A$_{23}$
70		P4$_6$						$\overline{\text{CS1}}$/A$_{22}$
71		P4$_5$						$\overline{\text{CS2}}$/A$_{21}$
72		P4$_4$						$\overline{\text{CS3}}$/A$_{20}$
73		P4$_3$						A$_{19}$
74	V_{CC2}							
75		P4$_2$						A$_{18}$
76	V_{SS}							
77		P4$_1$						A$_{17}$
78		P4$_0$						A$_{16}$
79		P3$_7$						A$_{15}$(/D$_{15}$)
80		P3$_6$						A$_{14}$(/D$_{14}$)
81		P3$_5$						A$_{13}$(/D$_{13}$)
82		P3$_4$						A$_{12}$(/D$_{12}$)
83		P3$_3$						A$_{11}$(/D$_{11}$)
84		P3$_2$						A$_{10}$(/D$_{10}$)
85		P3$_1$						A$_9$(/D$_9$)
86		P12$_4$						
87		P12$_3$						
88		P12$_2$						
89		P12$_1$						
90		P12$_0$						
91	V_{CC2}							
92		P3$_0$						A$_8$(/D$_8$)
93	V_{SS}							
94		P2$_7$					AN2$_7$	A$_7$(/D$_7$)
95		P2$_6$					AN2$_6$	A$_6$(/D$_6$)
96		P2$_5$					AN2$_5$	A$_5$(/D$_5$)

NOTES:
1. Bus control pins in M32C/84T cannot be used.

Table 1.6 Pin Description (100-Pin and 144-Pin Packages) (Continued)

Classsfication	Symbol	I/O Type	Supply Voltage	Function
Reference Voltage Input	V_{REF}	I	-	Applies reference voltage to the A/D converter and D/A converter
A/D Converter	AN_0 to AN_7 $AN0_0$ to $AN0_7$ $AN2_0$ to $AN2_7$	I	V_{CC1}	Analog input pins for the A/D converter
	$\overline{ADTRG}$	I	V_{CC1}	Input pin for an external A/D trigger
	ANEX0	I/O	V_{CC1}	Extended analog input pin for the A/D converter and output pin in external op-amp connection mode
	ANEX1	I	V_{CC1}	Extended analog input pin for the A/D converter
D/A Converter	DA0, DA1	O	V_{CC1}	Output pin for the D/A converter
Intelligent I/O	$INPC1_0$ to $INPC1_3$	I	V_{CC1}/V_{CC2}(1)	Input pins for the time measurement function
	$INPC1_4$ to $INPC1_7$	I	V_{CC1}	
	$OUTC1_0$ to $OUTC1_3$	O	V_{CC1}/V_{CC2}(1)	Output pins for the waveform generating function
	$OUTC1_4$ to $OUTC1_7$	O	V_{CC1}	($OUTC1_6$ and $OUTC1_7$ assgined to $P7_0$ and $P7_1$ are pins for the N-channel open drain output.)
	ISCLK0	I/O	V_{CC1}	Inputs and outputs the clock for the intellignet I/O communication function
	ISCLK1	I/O	V_{CC1}/V_{CC2}(1)	
	ISRXD0	I	V_{CC1}	Inputs data for the intellignet I/O communication function
	ISRXD1	I	V_{CC1}/V_{CC2}(1)	
	ISTXD0	O	V_{CC1}	Outputs data for the intellignet I/O communication function
	ISTXD1	O	V_{CC1}/V_{CC2}(1)	
	$BE1_{IN}$	I	V_{CC1}/V_{CC2}(1)	Inputs data for the intellignet I/O communication function
	$BE1_{OUT}$	O	V_{CC1}/V_{CC2}(1)	Outputs data for the intellignet I/O communication function
CAN	$CAN0_{IN}$	I	V_{CC1}	Input pin for the CAN communication function
	$CAN0_{OUT}$	O	V_{CC1}	Output pin for the CAN communication function
I/O Ports	$P0_0$ to $P0_7$ $P1_0$ to $P1_7$ $P2_0$ to $P2_7$ $P3_0$ to $P3_7$ $P4_0$ to $P4_7$ $P5_0$ to $P5_7$	I/O	V_{CC2}	I/O ports for CMOS. Each port can be programmed for input or output under the control of the direction register. An input port can be set, by program, for a pull-up resistor available or for no pull-up resister available in 4-bit units
	$P6_0$ to $P6_7$ $P7_0$ to $P7_7$ $P9_0$ to $P9_7$ $P10_0$ to $P10_7$	I/O	V_{CC1}	I/O ports having equivalent functions to P0 ($P7_0$ and $P7_1$ are ports for the N-channel open drain output.)
	$P8_0$ to $P8_4$ $P8_6$, $P8_7$	I/O	V_{CC1}	I/O ports having equivalent functions to P0
Input Port	$P8_5$	I	V_{CC1}	Shares a pin with $\overline{NMI}$. $\overline{NMI}$ input state can be got by reading $P8_5$

I : Input O : Output I/O : Input and output

NOTES:

1. V_{CC2} is not available in the 100-pin package. V_{CC1} only available.

Address	Register	Symbol	Value after RESET
00F0$_{16}$	Data Compare Register 00	G0CMP0	XX$_{16}$
00F1$_{16}$	Data Compare Register 01	G0CMP1	XX$_{16}$
00F2$_{16}$	Data Compare Register 02	G0CMP2	XX$_{16}$
00F3$_{16}$	Data Compare Register 03	G0CMP3	XX$_{16}$
00F4$_{16}$	Data Mask Register 00	G0MSK0	XX$_{16}$
00F5$_{16}$	Data Mask Register 01	G0MSK1	XX$_{16}$
00F6$_{16}$	Communication Clock Select Register	CCS	XXXX 0000$_2$
00F7$_{16}$			
00F8$_{16}$ 00F9$_{16}$	Receive CRC Code Register 0	G0RCRC	XX$_{16}$ XX$_{16}$
00FA$_{16}$ 00FB$_{16}$	Transmit CRC Code Register 0	G0TCRC	00$_{16}$ 00$_{16}$
00FC$_{16}$	SI/O Extended Mode Register 0	G0EMR	00$_{16}$
00FD$_{16}$	SI/O Extended Receive Control Register 0	G0ERC	00$_{16}$
00FE$_{16}$	SI/O Special Communication Interrupt Detect Register 0	G0IRF	00$_{16}$
00FF$_{16}$	SI/O Extended Transmit Control Register 0	G0ETC	0000 0XXX$_2$
0100$_{16}$ 0101$_{16}$	Time Measurement/Waveform Generating Register 10	G1TM0/G1PO0	XX$_{16}$ XX$_{16}$
0102$_{16}$ 0103$_{16}$	Time Measurement/Waveform Generating Register 11	G1TM1/G1PO1	XX$_{16}$ XX$_{16}$
0104$_{16}$ 0105$_{16}$	Time Measurement/Waveform Generating Register 12	G1TM2/G1PO2	XX$_{16}$ XX$_{16}$
0106$_{16}$ 0107$_{16}$	Time Measurement/Waveform Generating Register 13	G1TM3/G1PO3	XX$_{16}$ XX$_{16}$
0108$_{16}$ 0109$_{16}$	Time Measurement/Waveform Generating Register 14	G1TM4/G1PO4	XX$_{16}$ XX$_{16}$
010A$_{16}$ 010B$_{16}$	Time Measurement/Waveform Generating Register 15	G1TM5/G1PO5	XX$_{16}$ XX$_{16}$
010C$_{16}$ 010D$_{16}$	Time Measurement/Waveform Generating Register 16	G1TM6/G1PO6	XX$_{16}$ XX$_{16}$
010E$_{16}$ 010F$_{16}$	Time Measurement/Waveform Generating Register 17	G1TM7/G1PO7	XX$_{16}$ XX$_{16}$
0110$_{16}$	Waveform Generating Control Register 10	G1POCR0	0000 X000$_2$
0111$_{16}$	Waveform Generating Control Register 11	G1POCR1	0X00 X000$_2$
0112$_{16}$	Waveform Generating Control Register 12	G1POCR2	0X00 X000$_2$
0113$_{16}$	Waveform Generating Control Register 13	G1POCR3	0X00 X000$_2$
0114$_{16}$	Waveform Generating Control Register 14	G1POCR4	0X00 X000$_2$
0115$_{16}$	Waveform Generating Control Register 15	G1POCR5	0X00 X000$_2$
0116$_{16}$	Waveform Generating Control Register 16	G1POCR6	0X00 X000$_2$
0117$_{16}$	Waveform Generating Control Register 17	G1POCR7	0X00 X000$_2$
0118$_{16}$	Time Measurement Control Register 10	G1TMCR0	00$_{16}$
0119$_{16}$	Time Measurement Control Register 11	G1TMCR1	00$_{16}$
011A$_{16}$	Time Measurement Control Register 12	G1TMCR2	00$_{16}$
011B$_{16}$	Time Measurement Control Register 13	G1TMCR3	00$_{16}$
011C$_{16}$	Time Measurement Control Register 14	G1TMCR4	00$_{16}$
011D$_{16}$	Time Measurement Control Register 15	G1TMCR5	00$_{16}$
011E$_{16}$	Time Measurement Control Register 16	G1TMCR6	00$_{16}$
011F$_{16}$	Time Measurement Control Register 17	G1TMCR7	00$_{16}$

X: Indeterminate

Blank spaces are reserved. No access is allowed.

Address	Register	Symbol	Value after RESET
01E0₁₆	CAN0 Message Slot Buffer 0 Standard ID0	C0SLOT0_0	XX₁₆
01E1₁₆	CAN0 Message Slot Buffer 0 Standard ID1	C0SLOT0_1	XX₁₆
01E2₁₆	CAN0 Message Slot Buffer 0 Extended ID0	C0SLOT0_2	XX₁₆
01E3₁₆	CAN0 Message Slot Buffer 0 Extended ID1	C0SLOT0_3	XX₁₆
01E4₁₆	CAN0 Message Slot Buffer 0 Extended ID2	C0SLOT0_4	XX₁₆
01E5₁₆	CAN0 Message Slot Buffer 0 Data Length Code	C0SLOT0_5	XX₁₆
01E6₁₆	CAN0 Message Slot Buffer 0 Data 0	C0SLOT0_6	XX₁₆
01E7₁₆	CAN0 Message Slot Buffer 0 Data 1	C0SLOT0_7	XX₁₆
01E8₁₆	CAN0 Message Slot Buffer 0 Data 2	C0SLOT0_8	XX₁₆
01E9₁₆	CAN0 Message Slot Buffer 0 Data 3	C0SLOT0_9	XX₁₆
01EA₁₆	CAN0 Message Slot Buffer 0 Data 4	C0SLOT0_10	XX₁₆
01EB₁₆	CAN0 Message Slot Buffer 0 Data 5	C0SLOT0_11	XX₁₆
01EC₁₆	CAN0 Message Slot Buffer 0 Data 6	C0SLOT0_12	XX₁₆
01ED₁₆	CAN0 Message Slot Buffer 0 Data 7	C0SLOT0_13	XX₁₆
01EE₁₆	CAN0 Message Slot Buffer 0 Time Stamp High-Order	C0SLOT0_14	XX₁₆
01EF₁₆	CAN0 Message Slot Buffer 0 Time Stamp Low-Order	C0SLOT0_15	XX₁₆
01F0₁₆	CAN0 Message Slot Buffer 1 Standard ID0	C0SLOT1_0	XX₁₆
01F1₁₆	CAN0 Message Slot Buffer 1 Standard ID1	C0SLOT1_1	XX₁₆
01F2₁₆	CAN0 Message Slot Buffer 1 Extended ID0	C0SLOT1_2	XX₁₆
01F3₁₆	CAN0 Message Slot Buffer 1 Extended ID1	C0SLOT1_3	XX₁₆
01F4₁₆	CAN0 Message Slot Buffer 1 Extended ID2	C0SLOT1_4	XX₁₆
01F5₁₆	CAN0 Message Slot Buffer 1 Data Length Code	C0SLOT1_5	XX₁₆
01F6₁₆	CAN0 Message Slot Buffer 1 Data 0	C0SLOT1_6	XX₁₆
01F7₁₆	CAN0 Message Slot Buffer 1 Data 1	C0SLOT1_7	XX₁₆
01F8₁₆	CAN0 Message Slot Buffer 1 Data 2	C0SLOT1_8	XX₁₆
01F9₁₆	CAN0 Message Slot Buffer 1 Data 3	C0SLOT1_9	XX₁₆
01FA₁₆	CAN0 Message Slot Buffer 1 Data 4	C0SLOT1_10	XX₁₆
01FB₁₆	CAN0 Message Slot Buffer 1 Data 5	C0SLOT1_11	XX₁₆
01FC₁₆	CAN0 Message Slot Buffer 1 Data 6	C0SLOT1_12	XX₁₆
01FD₁₆	CAN0 Message Slot Buffer 1 Data 7	C0SLOT1_13	XX₁₆
01FE₁₆	CAN0 Message Slot Buffer 1 Time Stamp High-Order	C0SLOT1_14	XX₁₆
01FF₁₆	CAN0 Message Slot Buffer 1 Time Stamp Low-Order	C0SLOT1_15	XX₁₆
0200₁₆ 0201₁₆	CAN0 Control Register 0	C0CTLR0	XX01 0X01₂(1) XXXX 0000₂(1)
0202₁₆ 0203₁₆	CAN0 Status Register	C0STR	0000 0000₂(1) X000 0X01₂(1)
0204₁₆ 0205₁₆	CAN0 Extended ID Register	C0IDR	00₁₆(1) 00₁₆(1)
0206₁₆ 0207₁₆	CAN0 Configuration Register	C0CONR	0000 XXXX₂(1) 0000 0000₂(1)
0208₁₆ 0209₁₆	CAN0 Time Stamp Register	C0TSR	00₁₆(1) 00₁₆(1)
020A₁₆	CAN0 Transmit Error Count Register	C0TEC	00₁₆(1)
020B₁₆	CAN0 Receive Error Count Register	C0REC	00₁₆(1)
020C₁₆ 020D₁₆	CAN0 Slot Interrupt Status Register	C0SISTR	00₁₆(1) 00₁₆(1)
020E₁₆			
020F₁₆			

X: Indeterminate

Blank spaces are reserved. No access is allowed.

NOTES:

1. Values are obtained by setting the SLEEP bit in the C0SLPR register to "1" (sleep mode exited) after reset and supplying the clock to the CAN module.

<144-pin Package>

Address	Register	Symbol	Value after RESET
03A0$_{16}$	Function Select Register A8	PS8	X000 0000$_2$
03A1$_{16}$	Function Select Register A9	PS9	00$_{16}$
03A2$_{16}$			
03A3$_{16}$			
03A4$_{16}$			
03A5$_{16}$			
03A6$_{16}$			
03A7$_{16}$	Function Select Register D1	PSD1	X0XX XX00$_2$
03A8$_{16}$			
03A9$_{16}$			
03AA$_{16}$			
03AB$_{16}$			
03AC$_{16}$	Function Select Register C2	PSC2	XXXX X00X$_2$
03AD$_{16}$	Function Select Register C3	PSC3	X0XX XXXX$_2$
03AE$_{16}$			
03AF$_{16}$	Function Select Register C	PSC	00X0 0000$_2$
03B0$_{16}$	Function Select Register A0	PS0	00$_{16}$
03B1$_{16}$	Function Select Register A1	PS1	00$_{16}$
03B2$_{16}$	Function Select Register B0	PSL0	00$_{16}$
03B3$_{16}$	Function Select Register B1	PSL1	00$_{16}$
03B4$_{16}$	Function Select Register A2	PS2	00X0 0000$_2$
03B5$_{16}$	Function Select Register A3	PS3	00$_{16}$
03B6$_{16}$	Function Select Register B2	PSL2	00X0 0000$_2$
03B7$_{16}$	Function Select Register B3	PSL3	00$_{16}$
03B8$_{16}$			
03B9$_{16}$	Function Select Register A5	PS5	XXX0 0000$_2$
03BA$_{16}$			
03BB$_{16}$			
03BC$_{16}$			
03BD$_{16}$			
03BE$_{16}$			
03BF$_{16}$			
03C0$_{16}$	Port P6 Register	P6	XX$_{16}$
03C1$_{16}$	Port P7 Register	P7	XX$_{16}$
03C2$_{16}$	Port P6 Direction Register	PD6	00$_{16}$
03C3$_{16}$	Port P7 Direction Register	PD7	00$_{16}$
03C4$_{16}$	Port P8 Register	P8	XX$_{16}$
03C5$_{16}$	Port P9 Register	P9	XX$_{16}$
03C6$_{16}$	Port P8 Direction Register	PD8	00X0 0000$_2$
03C7$_{16}$	Port P9 Direction Register	PD9	00$_{16}$
03C8$_{16}$	Port P10 Register	P10	XX$_{16}$
03C9$_{16}$	Port P11 Register	P11	XX$_{16}$
03CA$_{16}$	Port P10 Direction Register	PD10	00$_{16}$
03CB$_{16}$	Port P11 Direction Register	PD11	XXX0 0000$_2$
03CC$_{16}$	Port P12 Register	P12	XX$_{16}$
03CD$_{16}$	Port P13 Register	P13	XX$_{16}$
03CE$_{16}$	Port P12 Direction Register	PD12	00$_{16}$
03CF$_{16}$	Port P13 Direction Register	PD13	00$_{16}$

X: Indeterminate

Blank spaces are reserved. No access is allowed.

$V_{CC1}=V_{CC2}=5V$

Timing Requirements

($V_{CC1}=V_{CC2}=4.2$ to 5.5V, $V_{SS}=0V$ at Topr=–20 to 85°C unless otherwise specified)

Table 5.9 External Clock Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tc	External Clock Input Cycle Time	31.25		ns
$t_{W(H)}$	External Clock Input High ("H") Width	13.75		ns
$t_{W(L)}$	External Clock Input Low ("L") Width	13.75		ns
tr	External Clock Rise Time		5	ns
tf	External Clock Fall Time		5	ns

Table 5.10 Memory Expansion Mode and Microprocessor Mode

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{AC1(RD-DB)}$	Data Input Access Time (RD standard)		(Note 1)	ns
$t_{AC1(AD-DB)}$	Data Input Access Time (AD standard, CS standard)		(Note 1)	ns
$t_{AC2(RD-DB)}$	Data Input Access Time (RD standard, when accessing a space with the multiplexrd bus)		(Note 1)	ns
$t_{AC2(AD-DB)}$	Data Input Access Time (AD standard, when accessing a space with the multiplexed bus)		(Note 1)	ns
$t_{SU(DB-BCLK)}$	Data Input Setup Time	26		ns
$t_{SU(RDY-BCLK)}$	$\overline{RDY}$ Input Setup Time	26		ns
$t_{SU(HOLD-BCLK)}$	$\overline{HOLD}$ Input Setup Time	30		ns
$t_{H(RD-DB)}$	Data Input Hold Time	0		ns
$t_{H(BCLK-RDY)}$	$\overline{RDY}$ Input Hold Time	0		ns
$t_{H(BCLK-HOLD)}$	$\overline{HOLD}$ Input Hold Time	0		ns
$t_{D(BCLK-HLDA)}$	$\overline{HLDA}$ Output Delay Time		25	ns

NOTES:
1. Values can be obtained from the following equations, according to BCLK frequecncy and external bus cycles. Insert a wait state or lower the operation frequency, $f_{(BCLK)}$, if the calculated value is negative.

$$t_{AC1(RD-DB)} = \frac{10^9 \times m}{f_{(BCLK)} \times 2} - 35$$ [ns] (if external bus cycle is aϕ + bϕ, m=(bx2)+1)

$$t_{AC1(AD-DB)} = \frac{10^9 \times n}{f_{(BCLK)}} - 35$$ [ns] (if external bus cycle is aϕ + bϕ, n=a+b)

$$t_{AC2(RD-DB)} = \frac{10^9 \times m}{f_{(BCLK)} \times 2} - 35$$ [ns] (if external bus cycle is aϕ + bϕ, m=(bx2)-1)

$$t_{AC2(AD-DB)} = \frac{10^9 \times p}{f_{(BCLK)} \times 2} - 35$$ [ns] (if external bus cycle is aϕ + bϕ, p={(a+b-1)x2}+1)

$V_{CC1}=V_{CC2}=3.3V$

Table 5.24 Electrical Characteristics ($V_{CC1}=V_{CC2}=3.0$ to $3.6V$, $V_{SS}=0V$ at Topr = –20 to 85°C, f(BCLK)=24MHz unless otherwise specified)

Symbol	Parameter		Condition		Standard			Unit
					Min.	Typ.	Max.	
V_{OH}	Output High ("H") Voltage	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$	I_{OH}=-1mA		V_{CC2}-0.6		V_{CC2}	V
		$P6_0$-$P6_7$, $P7_2$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(1)			V_{CC1}-0.6		V_{CC1}	V
		X_{OUT}	I_{OH}=-0.1mA		2.7		V_{CC1}	V
		X_{COUT} High Power	No load applied			2.5		V
		X_{COUT} Low Power	No load applied			1.6		V
V_{OL}	Output Low ("L") Voltage	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_0$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(1)	I_{OL}=1mA				0.5	V
		X_{OUT}	I_{OL}=0.1mA				0.5	V
		X_{COUT} High Power	No load applied			0		V
		X_{COUT} Low Power	No load applied			0		V
V_{T+}-V_{T-}	Hysteresis	$\overline{HOLD}$, $\overline{RDY}$, $TA0_{IN}$-$TA4_{IN}$, $TB0_{IN}$-$TB5_{IN}$, $\overline{INT0}$-$\overline{INT5}$, $\overline{ADTRG}$, $\overline{CTS0}$-$\overline{CTS4}$, CLK0-CLK4, $TA0_{OUT}$-$TA4_{OUT}$, $\overline{NMI}$, $\overline{KI0}$-$\overline{KI3}$, RxD0-RxD4, SCL0-SCL4, SDA0-SDA4			0.2		1.0	V
		$\overline{RESET}$			0.2		1.8	V
I_{IH}	Input High ("H") Current	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_0$-$P7_7$, $P8_0$-$P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(1), X_{IN}, $\overline{RESET}$, CNV_{SS}, BYTE	V_I=3V				4.0	µA
I_{IL}	Input Low ("L") Current	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_0$-$P7_7$, $P8_0$-$P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(1), X_{IN}, $\overline{RESET}$, CNV_{SS}, BYTE	V_I=0V				-4.0	µA
R_{PULLUP}	Pull-up Resistance	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_2$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(1)	V_I=0V	Flash Memory	66	120	500	kΩ
				Masked ROM	40	70	500	kΩ
R_{fXIN}	Feedback Resistance	X_{IN}				3.0		MΩ
R_{fXCIN}	Feedback Resistance	X_{CIN}				20.0		MΩ
V_{RAM}	RAM Standby Voltage	in stop mode			2.0			V
I_{CC}	Power Supply Current	Measurement condition: In single-chip mode, output pins are left open and other pins are connected to V_{SS}.	f(BCLK)=24 MHz, Square wave, No division			22	35	mA
			f(BCLK)=32 kHz, In wait mode, Topr=25° C			10		µA
			While clock stops, Topr=25° C			0.8	5	µA
			While clock stops, Topr=85° C				50	µA

NOTES:

1. P11 to P15 are provided in the 144-pin package only.

$V_{CC1}=V_{CC2}=3.3V$

Switching Characteristics

($V_{CC1}=V_{CC2}$=3.0 to 3.6V, VSS = 0V at Topr = –20 to 85°C unless otherwise specified)

Table 5.40 Memory Expansion Mode and Microprocessor Mode (when accessing external memory space)

Symbol	Parameter	Measurement Condition	Standard		Unit
			Min.	Max.	
$t_{d(BCLK-AD)}$	Address Output Delay Time	See Figure 5.2		18	ns
$t_{h(BCLK-AD)}$	Address Output Hold Time (BCLK standard)		0		ns
$t_{h(RD-AD)}$	Address Output Hold Time (RD standard)(3)		0		ns
$t_{h(WR-AD)}$	Address Output Hold Time (WR standard)(3)		(Note 1)		ns
$t_{d(BCLK-CS)}$	Chip-Select Signal Output Delay Time			18	ns
$t_{h(BCLK-CS)}$	Chip-Select Signal Output Hold Time (BCLK standard)		0		ns
$t_{h(RD-CS)}$	Chip-Select Signal Output Hold Time (RD standard)(3)		0		ns
$t_{h(WR-CS)}$	Chip-Select Signal Output Hold Time (WR standard)(3)		(Note 1)		ns
$t_{d(BCLK-RD)}$	RD Signal Output Delay Time			18	ns
$t_{h(BCLK-RD)}$	RD Signal Output Hold Time		-3		ns
$t_{d(BCLK-WR)}$	WR Signal Output Delay Time			18	ns
$t_{h(BCLK-WR)}$	WR Signal Output Hold Time		0		ns
$t_{d(DB-WR)}$	Data Output Delay Time (WR standard)		(Note 2)		ns
$t_{h(WR-DB)}$	Data Output Hold Time (WR standard)(3)		(Note 1)		ns
$t_{w(WR)}$	WR Output Width		(Note 2)		ns

NOTES:

1. Values can be obtained from the following equations, according to BCLK frequency.

$$t_{h(WR-DB)} = \frac{10^9}{f_{(BCLK)} \times 2} - 20 \quad [ns]$$

$$t_{h(WR-AD)} = \frac{10^9}{f_{(BCLK)} \times 2} - 10 \quad [ns]$$

$$t_{h(WR-CS)} = \frac{10^9}{f_{(BCLK)} \times 2} - 10 \quad [ns]$$

2. Values can be obtained from the following equations, according to BCLK frequency and external bus cycles.

$$t_{w(WR)} = \frac{10^9 \times n}{f_{(BCLK)} \times 2} - 15 \quad [ns] \quad \text{(if external bus cycle is } a\phi + b\phi\text{, n=(b x 2)-1)}$$

$$t_{d(DB-WR)} = \frac{10^9 \times m}{f_{(BCLK)}} - 20 \quad [ns] \quad \text{(if external bus cycle is } a\phi + b\phi\text{, m=b)}$$

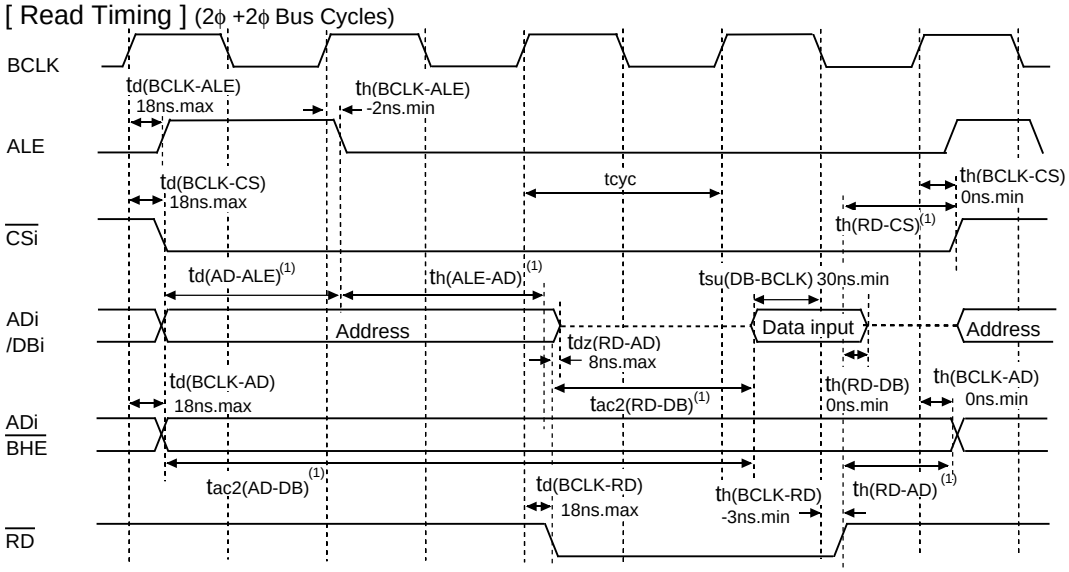
3. *tc* ns is added when recovery cycle is inserted.

Memory Expansion Mode and Microprocessor Mode

$V_{CC1}=V_{CC2}=3.3V$

(when accessing external memory space and using the multiplexed bus)

[Read Timing] (2φ +2φ Bus Cycles)



NOTES:

1. Varies with operation frequency:

$t_{d(AD-ALE)}$=(tcyc/2 x n-20)ns.min (if external bus cycle is aφ + bφ, n=a)

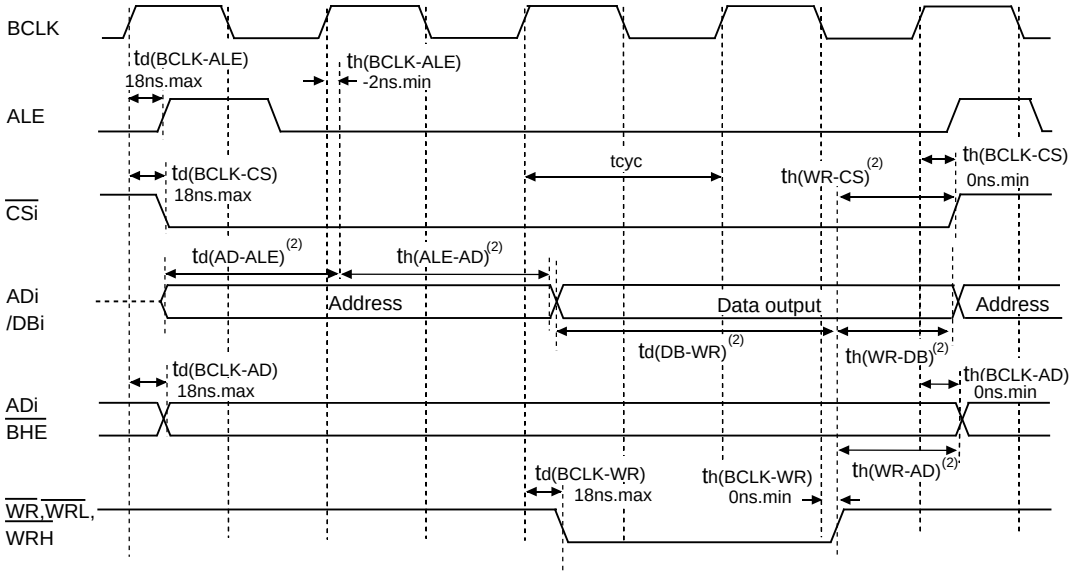
$t_{h(ALE-AD)}$=(tcyc/2 x n-10)ns.min (if external bus cycle is aφ + bφ, n=a)

$t_{h(RD-AD)}$=(tcyc/2-10)ns.min, $t_{h(RD-CS)}$=(tcyc/2-10)ns.min

$t_{ac2(RD-DB)}$=(tcyc/2 x m-35)ns.max (if external bus cycle is aφ + bφ, m=(b x 2)-1)

$t_{ac2(AD-DB)}$=(tcyc/2 x p-35)ns.max (if external bus cycle is aφ + bφ, p={(a+b-1) x 2}+1)

[Write Timing] (2φ +2φ Bus Cycles)



NOTES:

2. Varies with operation frequency:

$t_{d(AD-ALE)}$=(tcyc/2 x n - 20)ns.min

(if external bus cycle is aφ + bφ, n=a)

$t_{h(ALE-AD)}$=(tcyc/2 x n -10)ns.min

(if external bus cycle is aφ + bφ, n=a)

$t_{h(WR-AD)}$=(tcyc/2-10)ns.min,

$t_{h(WR-CS)}$=(tcyc/2-10)ns.min, $t_{h(WR-DB)}$=(tcyc/2-20)ns.min

$t_{d(DB-WR)}$=(tcyc/2 x m-25)ns.min

(if external bus cycle is aφ + bφ, m=(b x 2)-1)

Measurement Conditions:

- $V_{CC1}=V_{CC2}$=3.0 to 3.6V
- Input high and low voltage: V_{IH}=1.5V, V_{IL}=0.5V
- Output high and low voltage: V_{OH}=1.5V, V_{OL}=1.5V

$$tcyc=\frac{10^9}{f_{(BCLK)}}$$

Figure 5.8 $V_{CC1}=V_{CC2}$=3.3V Timing Diagram (2)

Table 5.43 Recommended Operating Conditions

(V_{CC1}=V_{CC2}=4.2 to 5.5V, V_{SS}=0V at Topr = -40 to 85°C (T version) unless otherwise specified)

Symbol	Parameter		Standard			Unit
			Min.	Typ.	Max.	
V_{CC1}, V_{CC2}	Supply Voltage (V_{CC1}≥ V_{CC2})		4.2	5.0	5.5	V
AVcc	Analog Supply Voltage			V_{CC1}		V
Vss	Supply Voltage			0		V
AVss	Analog Supply Voltage			0		V
V_{IH}	Input High ("H") Voltage	$P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$(4)	0.8V_{CC2}		V_{CC2}	V
		$P6_0$-$P6_7$, $P7_2$-$P7_7$, $P8_0$-$P8_7$(3), $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(4), X_{IN}, $\overline{RESET}$, CNVss, BYTE	0.8V_{CC1}		V_{CC1}	
		$P7_0$, $P7_1$	0.8V_{CC1}		6.0	
		$P0_0$-$P0_7$, $P1_0$-$P1_7$	0.8V_{CC2}		V_{CC2}	
V_{IL}	Input Low ("L") Voltage	$P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$(4)	0		0.2V_{CC2}	V
		$P6_0$-$P6_7$, $P7_0$-$P7_7$, $P8_0$-$P8_7$(3), $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(4), X_{IN}, $\overline{RESET}$, CNVss, BYTE	0		0.2V_{CC1}	
		$P0_0$-$P0_7$, $P1_0$-$P1_7$	0		0.2V_{CC2}	
$I_{OH(peak)}$	Peak Output High ("H") Current(2)	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_2$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(4)			-10.0	mA
$I_{OH(avg)}$	Average Output High ("H") Current(1)	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_2$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(4)			-5.0	mA
$I_{OL(peak)}$	Peak Output Low ("L") Current(2)	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_0$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(4)			10.0	mA
$I_{OL(avg)}$	Average Output Low ("L") Current(1)	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_0$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(4)			5.0	mA

NOTES:

1. Typical values when average output current is 100ms.
2. Total $I_{OL(peak)}$ for P0, P1, P2, $P8_6$, $P8_7$, P9, P10, P11, P14 and P15 must be 80mA or less.
   Total $I_{OL(peak)}$ for P3, P4, P5, P6, P7, $P8_0$ to $P8_4$, P12 and P13 must be 80mA or less.
   Total $I_{OH(peak)}$ for P0, P1, P2, and P11 must be -40mA or less.
   Total $I_{OH(peak)}$ for $P8_6$, $P8_7$, P9, P10, P14 and P15 must be -40mA or less.
   Total $I_{OH(peak)}$ for P3, P4, P5, P12 and P13 must be -40mA or less.
   Total $I_{OH(peak)}$ for P6, P7, and $P8_0$ to $P8_4$ must be -40mA or less.
3. V_{IH} and V_{IL} reference for $P8_7$ applies when $P8_7$ is used as a programmable input port.
   It does not apply when $P8_7$ is used as X_{CIN}.
4. P11 to P15 are provided in the 144-pin package only.

$V_{CC1}=V_{CC2}=5V$

Table 5.44 Electrical Characteristics (Continued)
($V_{CC1}=V_{CC2}=4.2$ to 5.5V, $V_{SS}=0V$ at Topr = -40 to 85°C (T version), f(BCLK)=32MHz unless otherwise specified)

Symbol	Parameter	Measurement Condition		Standard			Unit
				Min.	Typ.	Max.	
I_{CC}	Power Supply Current	In single-chip mode, output pins are left open and other pins are connected to V_{SS}.	f(BCLK)=32 MHz, Square wave, No division		28	50	mA
			f(BCLK)=32 kHz, In low-power consumption mode, Program running on ROM		430		µA
			f(BCLK)=32 kHz, In low-power consumption mode, Program running on RAM(1)		25		µA
			f(BCLK)=32 kHz, In wait mode, Topr=25° C		10		µA
			While clock stops, Topr=25° C		0.8	5	µA
			While clock stops, Topr=85° C			50	µA

NOTES:
1. Value is obtained when setting the FMSTP bit in the FMR0 register to "1" (flash memory stopped).

$V_{CC1}=V_{CC2}=5V$

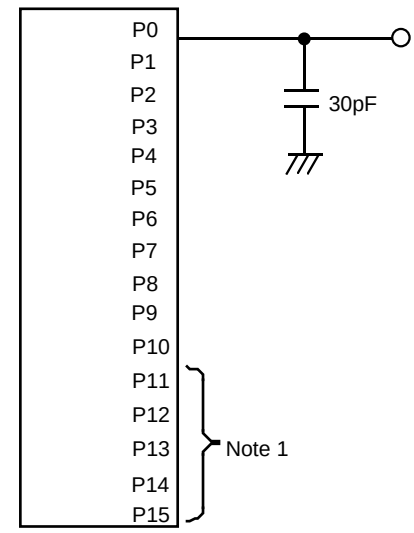
Timing Requirements

($V_{CC1}=V_{CC2}=4.2$ to 5.5V, $V_{SS}=0V$ at Topr= -40 to 85°C (T version) unless otherwise specified)

Table 5.49 External Clock Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tc	External Clock Input Cycle Time	31.25		ns
$tw_{(H)}$	External Clock Input High ("H") Width	13.75		ns
$tw_{(L)}$	External Clock Input Low ("L") Width	13.75		ns
tr	External Clock Rise Time		5	ns
tf	External Clock Fall Time		5	ns

$V_{CC1}=V_{CC2}=5V$



NOTES:
1. P11 to P15 are provided in the 144-pin package only.

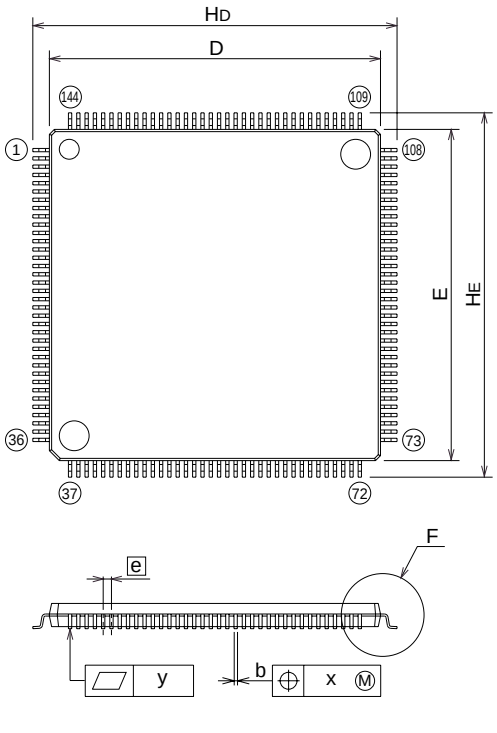
Figure 5.12 P0 to P15 Measurement Circuit

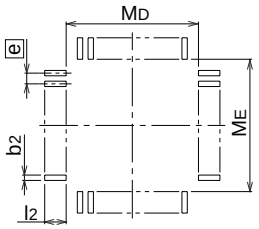
Package Dimensions

PLQP0144KA-A (144P6Q-A)

Plastic 144pin 20×20mm body LQFP

JEITA Package Code	RENESAS Code	Previous Code	Mass[Typ.]
P-LQFP144-20x20-0.50	PLQP0144KA-A	144P6Q-A	1.2g





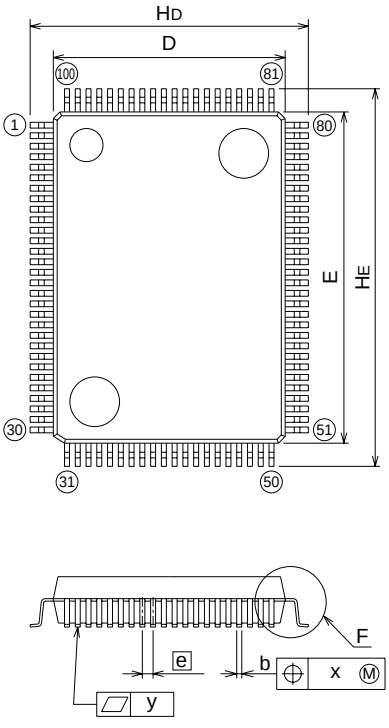
Recommended Mount Pad

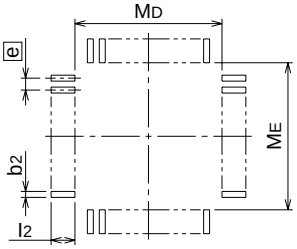
Symbol	Dimension in Millimeters		
	Min	Nom	Max
A	–	–	1.7
A1	0.05	0.125	0.2
A2	–	1.4	–
b	0.17	0.22	0.27
c	0.105	0.125	0.175
D	19.9	20.0	20.1
E	19.9	20.0	20.1
e	–	0.5	–
HD	21.8	22.0	22.2
HE	21.8	22.0	22.2
L	0.35	0.5	0.65
L1	–	1.0	–
Lp	0.45	0.6	0.75
A3	–	0.25	–
x	–	–	0.08
y	–	–	0.1
θ	0°	–	8°
b2	–	0.225	–
l2	0.95	–	–
MD	–	20.4	–
ME	–	20.4	–

PRQP0100JB-A (100P6S-A)

Plastic 100pin 14×20mm body QFP

JEITA Package Code	RENESAS Code	Previous Code	Mass[Typ.]
P-QFP100-14x20-0.65	PRQP0100JB-A	100P6S-A	1.6g





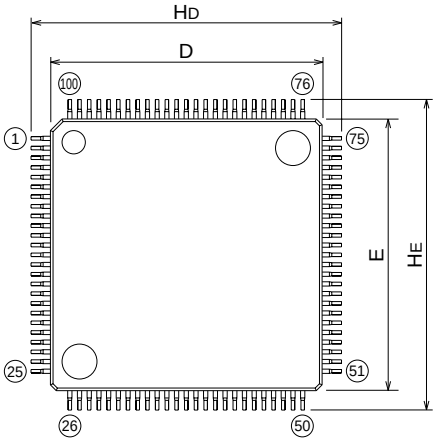
Recommended Mount Pad

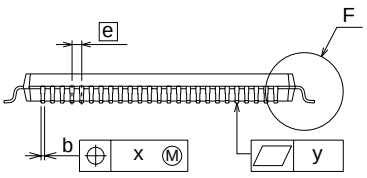
Symbol	Dimension in Millimeters		
	Min	Nom	Max
A	–	–	3.05
A1	0	0.1	0.2
A2	–	2.8	–
b	0.25	0.3	0.4
c	0.13	0.15	0.2
D	13.8	14.0	14.2
E	19.8	20.0	20.2
e	–	0.65	–
HD	16.5	16.8	17.1
HE	22.5	22.8	23.1
L	0.4	0.6	0.8
L1	–	1.4	–
x	–	–	0.13
y	–	–	0.1
θ	0°	–	10°
b2	–	0.35	–
l2	1.3	–	–
MD	–	14.6	–
ME	–	20.6	–

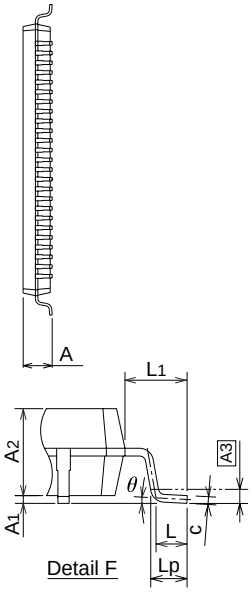
PLQP0100KB-A (100P6Q-A)

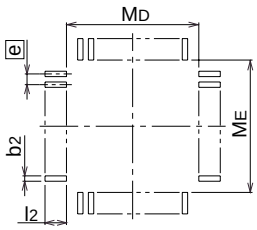
Plastic 100pin 14×14mm body LQFP

JEITA Package Code	RENESAS Code	Previous Code	Mass[Typ.]
P-LQFP100-14x14-0.50	PLQP0100KB-A	100P6Q-A	0.6g









Recommended Mount Pad

Symbol	Dimension in Millimeters		
	Min	Nom	Max
A	–	–	1.7
A1	0	0.1	0.2
A2	–	1.4	–
b	0.13	0.18	0.28
c	0.105	0.125	0.175
D	13.9	14.0	14.1
E	13.9	14.0	14.1
e	–	0.5	–
HD	15.8	16.0	16.2
HE	15.8	16.0	16.2
L	0.3	0.5	0.7
L1	–	1.0	–
Lp	0.45	0.6	0.75
A3	–	0.25	–
x	–	–	0.08
y	–	–	0.1
θ	0°	–	10°
b2	–	0.225	–
l2	0.9	–	–
MD	–	14.4	–
ME	–	14.4	–

Rev.	Date	Description	
		Page	Summary
		63	• **Table 5.28 Memory Expassion Mode and Microprocessor Mode** tsu(DB-BCLK), tsu(RDY-BCLK) and tsu(HOLD-BCLK) value modified
		66	• **Table 5.40 Memory Expassion Mode and Microprocessor Mode** equetion of th(WR-DB) modified
		67	• **Table 5.41 Memory Expassion Mode and Microprocessor Mode** th(BCLK-ALE) value modified; equetion of th(WR-DB) modified
		72	• **5.2 Electrical Characteristics (M32C/84T)** added
1.10	Jun.28, 2004	-	**High-reliability version (U version)** deleted
			Overview
		5	• **Table 1.3 M32C/84 Group (1) (2)** development status modified
		6	• **Figure 1.2 Product Numbering System** figure modified
1.20	Apr.18, 2005		**Overview**
		2, 3	• **Table 1.1** and **Table 1.2 M32C/84 Group (M32C/84, M32C/84T) Performance** Note 4 added
		6	• **Table 1.3 M32C/84 Group (1) (2)** Information updated
		16, 17	• **Table 1.6 Pin Description** Note 2 deleted
			Memory
		22	• **Figure 3.1 Memory Map** Description added to Note 3
			SFR
		24	• The PWCR0 and PWCR1 registers newly added to address $004C_{16}$ and $004D_{16}$
			• "Values after RESET" for the G0RB, G1BCR1, G1RB, IDB0, IDB1, DM0SL to DM3SL and PSC registers revised
			Electrical Characteristics
		46	• **Table 5.3 Electrical Characteristics** ICC standard value revised
		49	• **Table 5.6 Flash Memory Electrical Characteristics** Topr value modified
		50	• **Table 5.7 Voltage Detection Circuit Electrical Characteristics** VCC1 value modified
		58	• **Figure 5.4 VCC1=VCC2=5V Timing Diagram (2)** Diagram modified
		61	• **Table 5.24 Electrical Characteristics** ICC standard value revised
		63	• **Table 5.28 Memory Expansion Mode and Microprocessor Mode** tac1(AD-DB) expression modified
		75	• **Table 5.44 Electrical Characteristics** ICC standard value revised
		78	• **Table 5.47 Flash Memory Electrical Characteristics** Topr value modified
1.21	Jul.08, 2005		**Special Function Register (SFR)**
		37	• The TCSPR register Value after reset modified
			Electrical Characteristics
		45	• **Table 5.2 Electrical Characteristics** Parameter f(BCLK) and its values added
		51	• **Table 5.10 Memory Expansion Mode and Microprocessor Mode** *tac1(RD-DB)* expression on Note 1 modified; *tac2(RD-DB)* expression on Note 1 added